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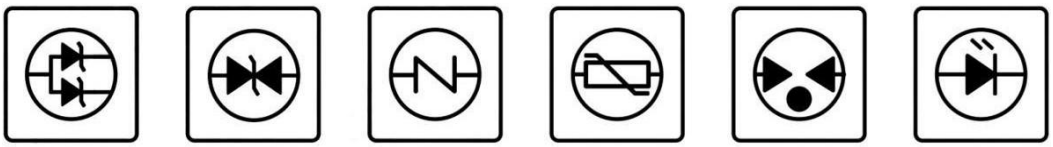
SEMICONDUCTOR



MSLR8xx

Product specification

General Description

The Top-Best IC MSLR8xx is a high voltage, low output current, adjustable linear regulator. It has a wide operating input voltage range of 13.2 - 450V. The output voltage can be adjusted from 1.20 - 440V provided that the input voltage is at least 12V greater than the output voltage. The output voltage can be adjusted by means of two external resistors R1 and R2 as shown in the typical application circuits . The MSLR8xx regulates the voltage difference between V_{OUT} and ADJ pins to a nominal value of 1.20V . The 1.20V is amplified by the external resistor ratio R1 and R2. An internal constant bias current of typically 10μA is connected to the ADJ pin. This increases V_{OUT} by a constant voltage of 10μA times R2.

The MSLR8xx has current limiting and temperature limiting.The output current limit is typically 20mA and the minimum temperature limit is 125°C. An output short circuit current will therefore be limited to 20mA. When the junction temperature reaches its temperature limit , the output current and/or output voltage will decrease to keep the junction temperature from exceeding its temperature limit. For SMPS start-up circuit applications, the MSLR8xx turns off when an external voltage greater than the output voltage of the MSLR8xx is applied to V_{OUT} of the MSLR8xx. to maintain stability, a bypass capacitor of 1.0μF or larger and a minimum DC output current of 500μA are required.

The device is available in SOT-89, TO-252 (D-PAK), and TO-92 packages.

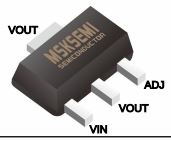
Features

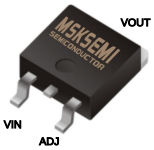
- 13.2 - 450V input voltage range
- Adjustable 1.20 - 440V output regulation
- 5% output voltage tolerance
- Output current limiting
- 10μA typical ADJ current
- Internal junction temperature limiting

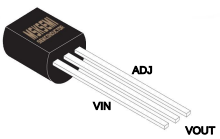
Applications

- Off-line SMPS startup circuits
- Adjustable high voltage constant current source
- Industrial controls
- Motor controls
- Battery chargers
- Power supplies

Reference News

SOT-89	Marking
	TBR8

TO-252	Marking
	TBR8

TO-92	Marking
	TBR8

Parameter	Value
V_{IN} input voltage (voltages ref to ADJ)	-0.5V to +480V
Output voltage range	-0.5V to +470V
Operating ambient temperature range	-40°C to +85°C
Operating junction temperature range	-40°C to +125°C
Storage temperature range	-65°C to +150°C

Stresses beyond those listed under"Absolute Maximum Ratings " may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Order information

Orderable Device	Package	Packing Option
MSLR8N8	SOT-89	1000PCS
MSLR8N3	TO-92	1000PCS
MSLR8K4	TO-252	2500PCS

Electrical Characteristics (Test conditions unless otherwise specified: -40℃ < T_A < 85℃.)

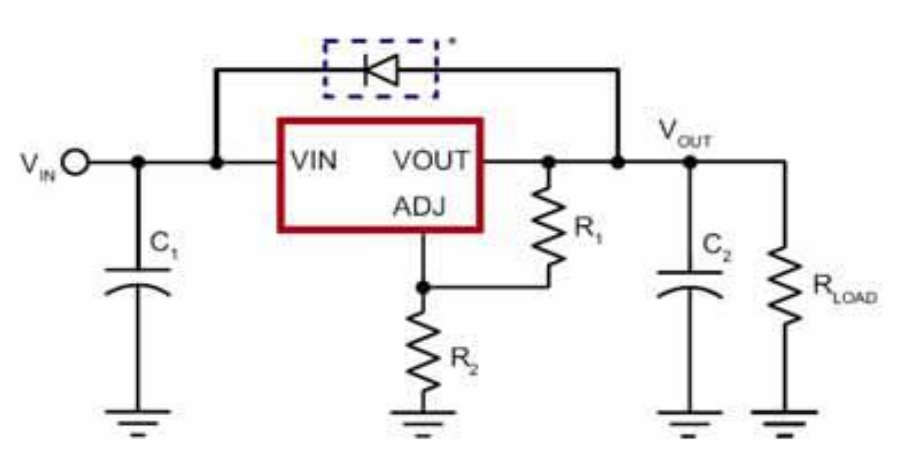
Sym	Parameter	Min	Typ	Max	Units	Conditions
V_{IN} - V_{OUT}	Input to output voltage difference	12	-	450	V	---
V_{OUT}	Overall output voltage regulation	1.14	1.20	1.26	V	13.2V < V_{IN} < 400V, R1 = 2.4KΩ, R2 = 0
V_{OUT}	Overall output voltage regulation	375	400	426	V	R1 = 2.4KΩ, R2 = 782KΩ
△V_{OUT}	Line regulation	-	0.003	0.01	%/V	17V < V_{IN} < 400V, V_{OUT} = 5V, I_{OUT} = 0.5mA
△V_{OUT}	Load regulation	-	1.4	3.0	%	V_{IN} = 17V, V_{OUT} = 5V, 0.5mA < I_{OUT} < 10mA
△V_{OUT}	Temperature regulation	-1	-	+1	%	V_{IN} = 17V, V_{OUT} = 5V, I_{OUT} = 10mA, -40℃ < T_A <85℃
I_{OUT}	Output current limit	10	-	30	mA	T_J < 85℃, V_{IN} - V_{OUT} = 12V
I_{OUT}	Output current limit	-	-	0.5	mA	T_J < 125℃, V_{IN} - V_{OUT} = 450V
I_{OUT}	Minimum output current	-	0.3	0.5	mA	Includes R1 and load current
I_{ADJ}	Adjust output current	5.0	10	15	uA	---
C2	Minimum output load capacitance	1.0	-	-	uF	---
DV_{OUT} / DV_{IN}	Ripple rejection ratio	50	60	-	dB	120Hz, V_{OUT} = 5V
T_{LIMIT}	Junction temperature limit	125	-	-	℃	---

Thermal Characteristics

Package	Power Dissipation @ T_A = 25°C	θjc °C/W	θja °C/W
TO-92	0.74W	125	170
TO-89	1.6W	15	78t
TO-252	2.5W	6.25	50t

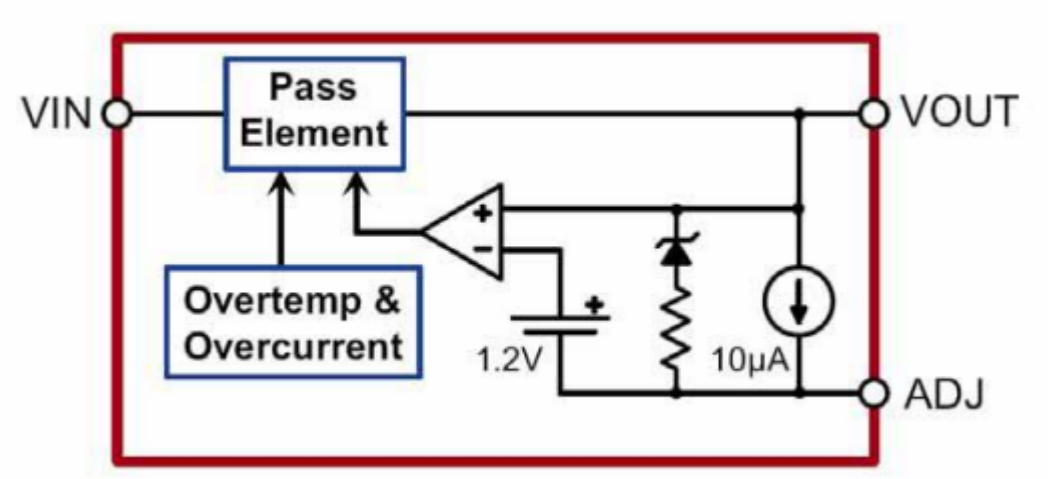
Note:
t Mountedon FR4board, 25mmx25mmx 1.57mm.

Typical Application Circuit

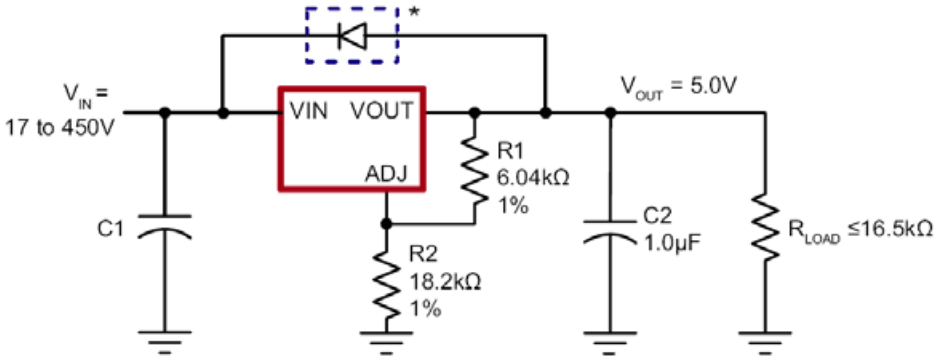


Required for conditions where V_{IN} is less than V_{OUT}

Functional Block Diagram



Typical Application Circuits



Required for conditions where V_{IN} is less than V_{OUT}, $V_{OUT} = 1.2V * \left(1 + \frac{R2}{R1}\right) + I_{ADJ} * R2$

Figure 1: High Input Voltage, 5.0V Output Linear Regulator

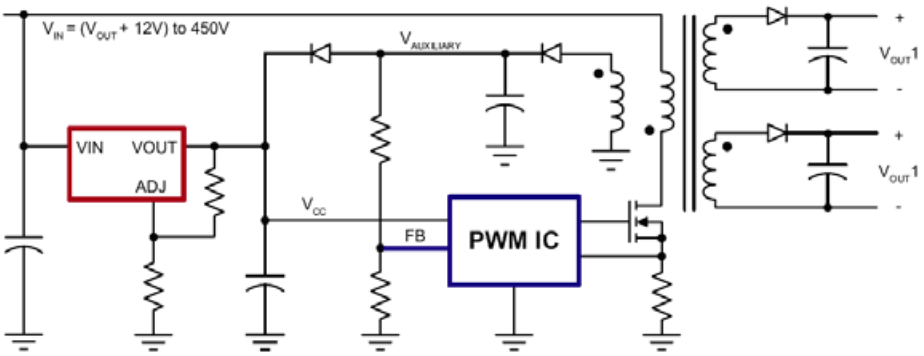


Figure 2: SMPS Start-Up Circuit

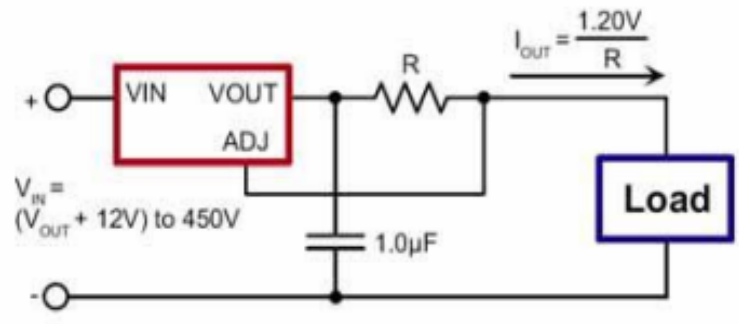
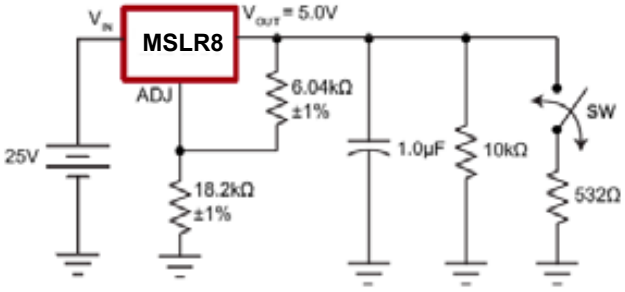
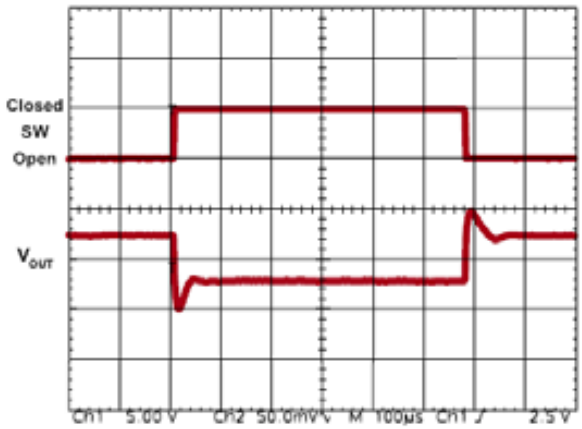


Figure 3: High Voltage Adjustable Constant Current Source

Typical Performance Curves

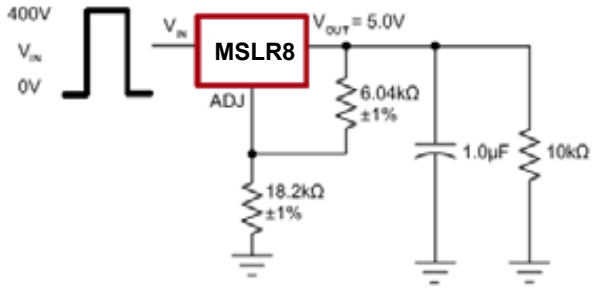
Load Transient Response

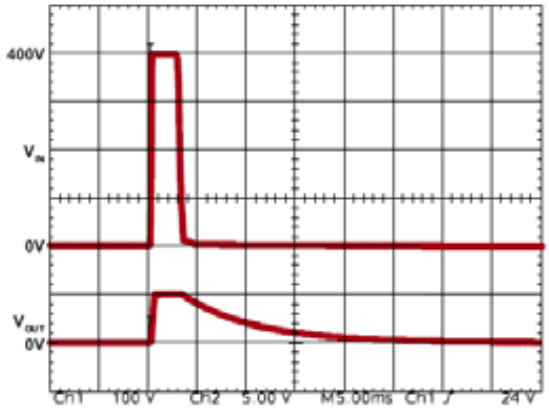




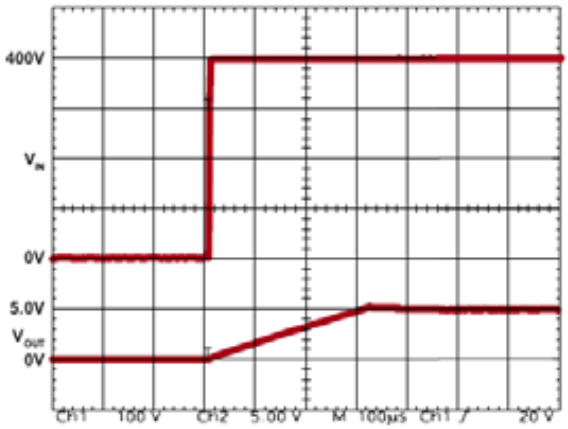
Load Transient Response

Line Transient Response

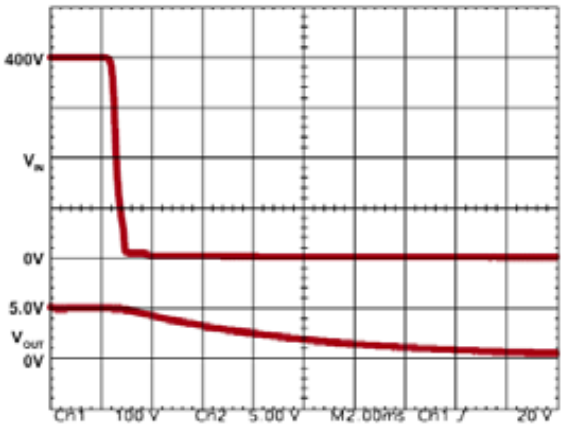




Line Transient Response



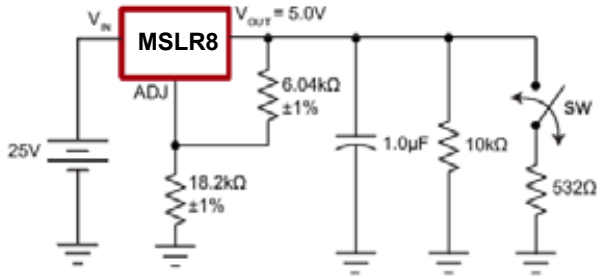
Line Power Up Transient

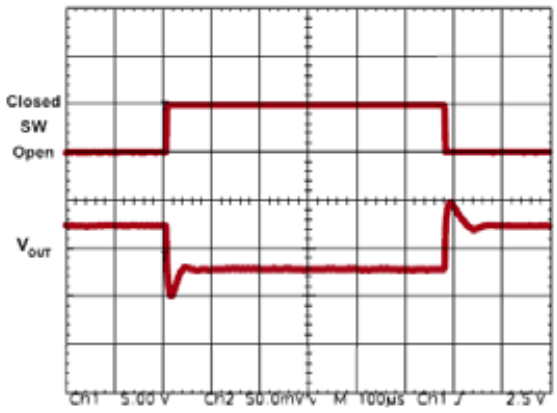


Line Power Down Transient

Typical Performance Curves (cont.)

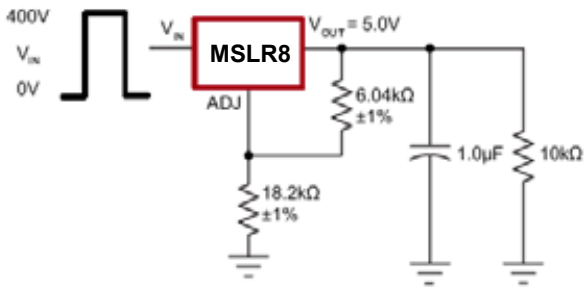
Load Transient Response

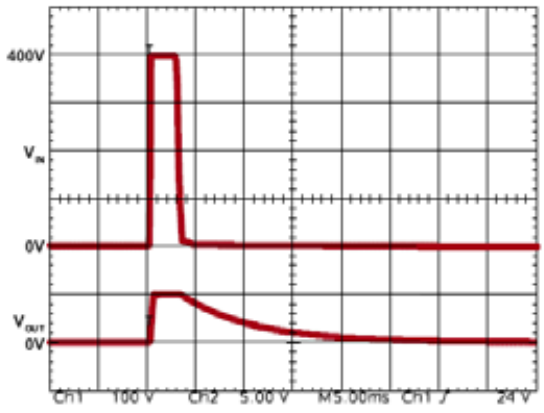




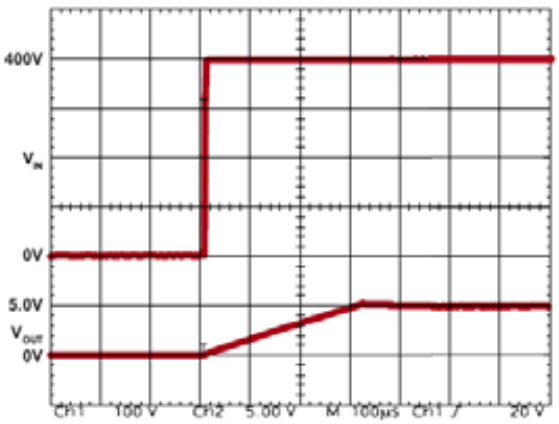
Load Transient Response

Line Transient Response

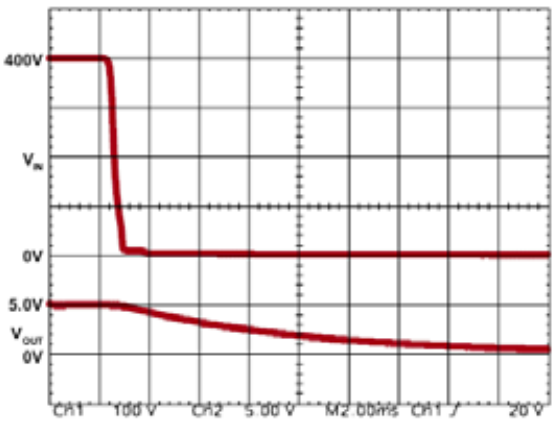




Line Transient Response



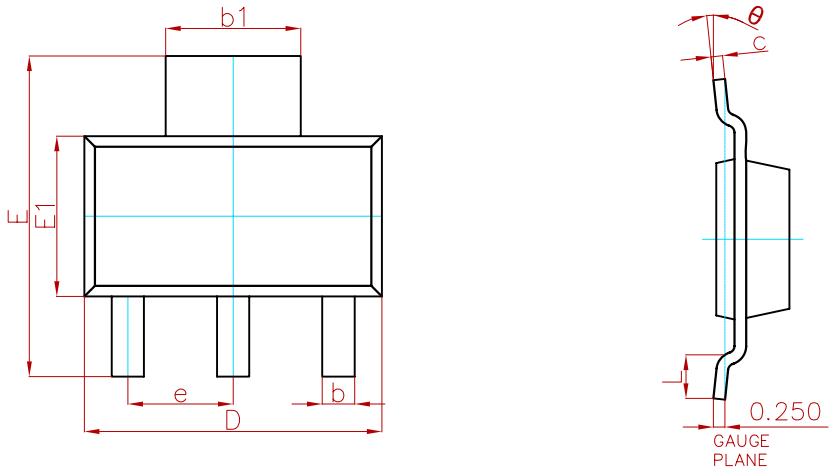
Line Power Up Transient



Line Power Down Transient

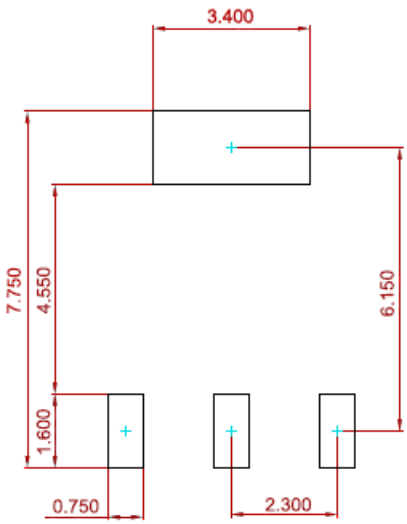
PACKAGE MECHANICAL DATA

SOT-89



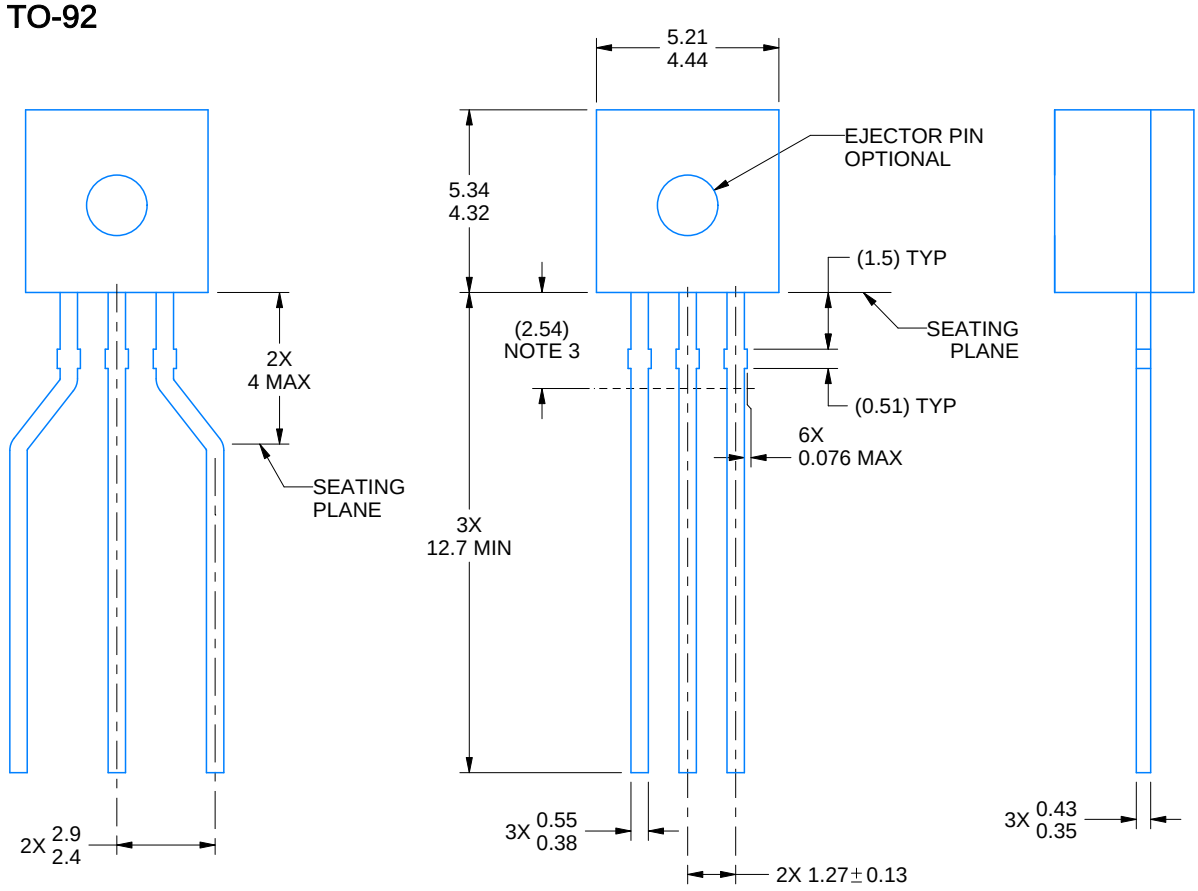
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	——	1.800	——	0.071
A1	0.020	0.100	0.001	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.840	0.026	0.033
b1	2.900	3.100	0.114	0.122
c	0.230	0.350	0.009	0.014
D	6.300	6.700	0.248	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.300(BSC)		0.091(BSC)	
L	0.750	——	0.030	——
θ	0°	10°	0°	10°

Suggested Pad Layout



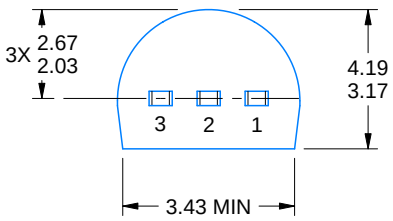
Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.050mm.
3.The pad layout is for reference purposes only.

TO-92

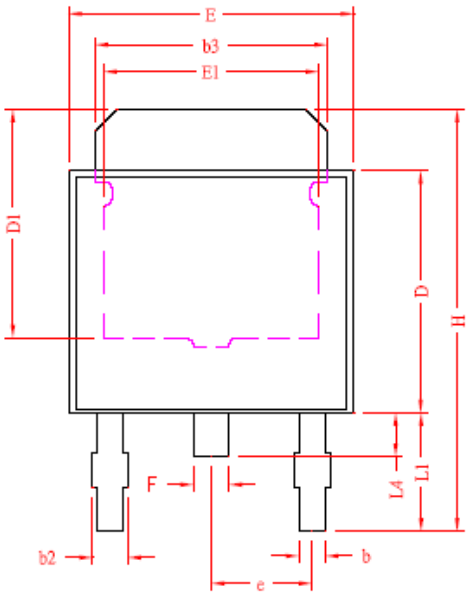


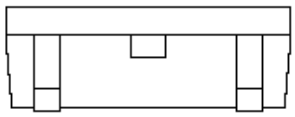
FORMED LEAD OPTION
OTHER DIMENSIONS IDENTICAL
TO STRAIGHT LEAD OPTION

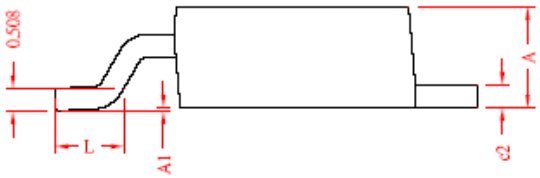
STRAIGHT LEAD OPTION



TO-252







REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.20	2.40	E	6.40	6.80
A1	0	0.15	E1	3.81	---
b	0.50	0.70	e	2.30 REF.	
b2	0.60	0.90	F	0.70	0.90
b3	5.20	5.50	H	9.40	10.20
c2	0.45	0.55	L	1.40	1.77
D	5.40	5.80	L1	2.40	3.00
D1	4.57	---	L4	0.80	1.20

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